

/ Revised record

| A | 2021-12-11 | ALL | Ver.D | BRD100N03 TO-252# | |
|---|------------|-----|-------|----------------------|--|
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BRD100N03

Rev.A Dec.-2021



DATA SHEET

/ Descriptions

TO-252 N MOS
N-CHANNEL MOSFET in a TO-252 Plastic Package.

/ Features

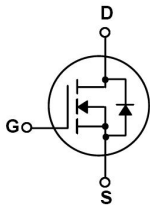
Low gate charge, low crss, fast switching. Halogen-free Product.

/ Applications

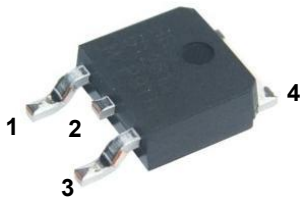
DC/DC

These devices are well suited for high efficiency switching DC/DC converters and switch mode power supplies.

/ Equivalent Circuit



/ Pinning



PIN1 G PIN 2 D PIN 3 S PIN 4 D

/ h_{FE} Classifications & Marking

See Marking Instructions.

/ Absolute Maximum Ratings(Ta=25)

| Parameter | | Symbol | Rating | Unit |
|---|--------------|-----------------------|------------|--------------|
| Drain-Source Voltage | | V_{DSS} | 30 | V |
| Drain Current | | $I_D(T_C=25^\circ C)$ | 100 | A |
| Peak Drain Current | | I_{DM} | 350 | A |
| Gate-Source Voltage | | V_{GSS} | ± 20 | V |
| Avalanche Current | | I_{AS} | 30 | A |
| Single Pulsed Avalanche Energy | | E_{AS} | 360 | mJ |
| Total Power Dissipation | | $P_D(T_C=25^\circ C)$ | 100 | W |
| Junction and Storage Temperature Range | | T_J, T_{STG} | -55 to 150 | $^\circ C$ |
| Thermal resistance, junction - ambient | $t \leq 10s$ | $R_{\theta JA}$ | 20 | $^\circ C/W$ |
| | Steady-State | | 50 | |
| Thermal resistance, junction - case | Steady-State | $R_{\theta JC}$ | 1.8 | |

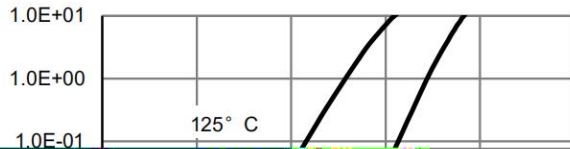
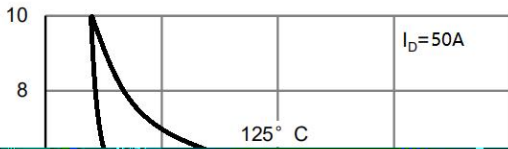
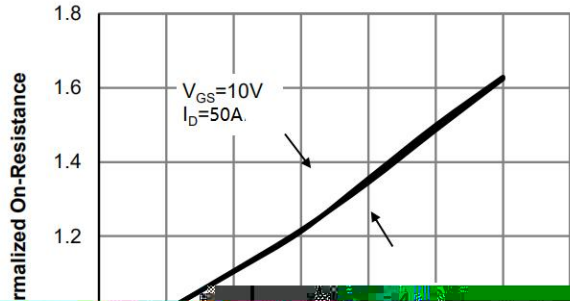
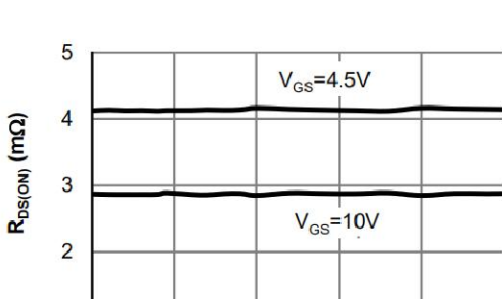
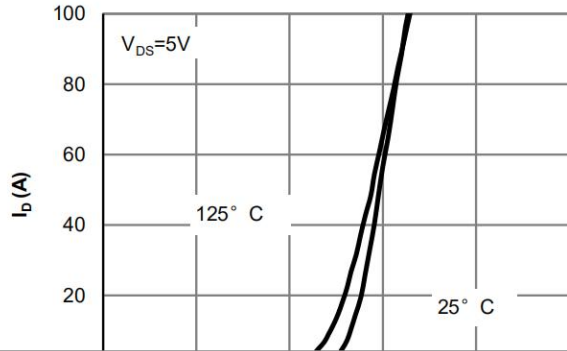
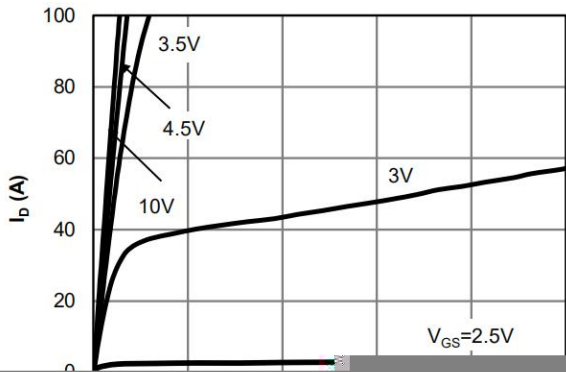
/ Electrical Characteristics(Ta=25)

| Parameter | Symbol | Test Conditions | | Min | Typ | Max | Unit |
|--------------------------------------|--------------|-----------------------------|----------------|-----|------|-----------|------------|
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{GS}=0V$ | $I_D=250\mu A$ | 30 | 32 | | V |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS}=30V$ | $V_{GS}=0V$ | | | 1 | μA |
| Gate-Body Leakage Current Forward | I_{GSS} | $V_{GS}=\pm 20V$ | $V_{DS}=0V$ | | | ± 0.1 | μA |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS}=V_{GS}$ | $I_D=250\mu A$ | 1.0 | 1.7 | 3.0 | V |
| Forward On Voltage | V_{SD} | $I_S=20A$ | $V_{GS}=0V$ | | | 1.2 | V |
| Static Drain-Source On-Resistance | $R_{DS(on)}$ | $V_{GS}=10V$ | $I_D=50A$ | | 2.8 | 3.8 | m Ω |
| | | $V_{GS}=4.5V$ | $I_D=40A$ | | 4.0 | 7.0 | m Ω |
| Gate resistance | R_g | $V_{GS}=0V$ $f=1MHz$ | $V_{DS}=0V$ | | 1.8 | | Ω |
| Input Capacitance | C_{iss} | $V_{GS}=0V$ $V_{DS}=25V$ | $f=1.0MHz$ | | 2500 | | pF |
| Output Capacitance | C_{oss} | | | | 310 | | pF |
| Reverse Transfer Capacitance | C_{rss} | | | | 275 | | pF |

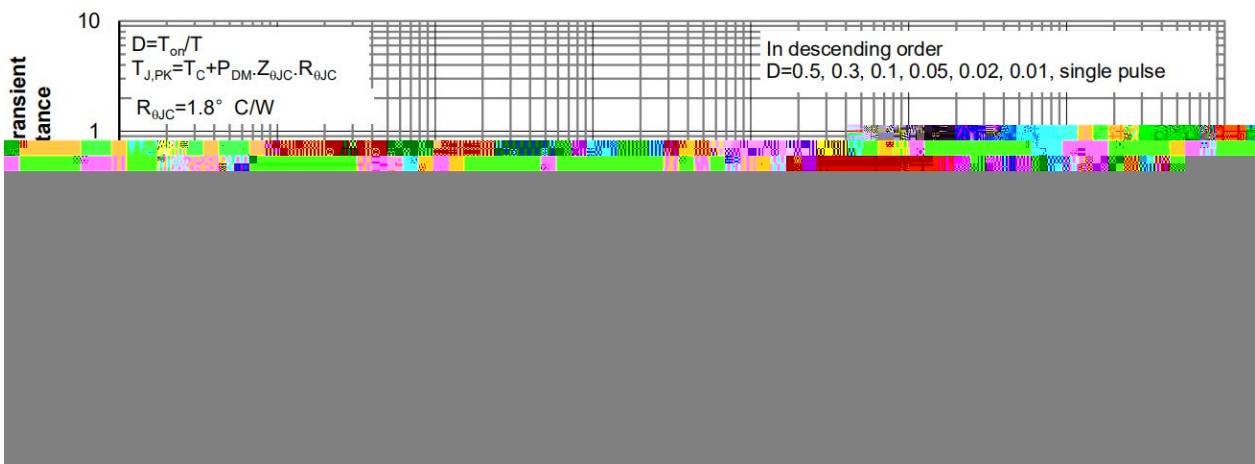
/ Electrical Characteristics(Ta=25)

| Parameter | Symbol | Test Conditions | Min | Typ | Max | Unit |
|---------------------|---------------|---|-----|------|-----|------|
| Total Gate Charge | $Q_{g(10V)}$ | $V_{GS}=10V,$ $I_D=20A$ $V_{DS}=15V,$ | | 80 | | nC |
| Total Gate Charge | $Q_{g(4.5V)}$ | | | 35 | | |
| Gate Source Charge | Q_{gs} | | | 13 | | |
| Gate Drain Charge | Q_{gd} | | | 13 | | |
| Turn-On Delay Time | $t_{d(on)}$ | $V_{DD}=15V$ $R_{GEN}=6\Omega$ $I_D=1A$ $V_{GS}=10V$ | | 25.7 | 50 | ns |
| Turn-On Rise Time | t_r | | | 10 | 20 | ns |
| Turn-Off Delay Time | $t_{d(off)}$ | | | 128 | 200 | ns |
| Turn-Off Fall Time | t_f | | | 34 | 70 | ns |

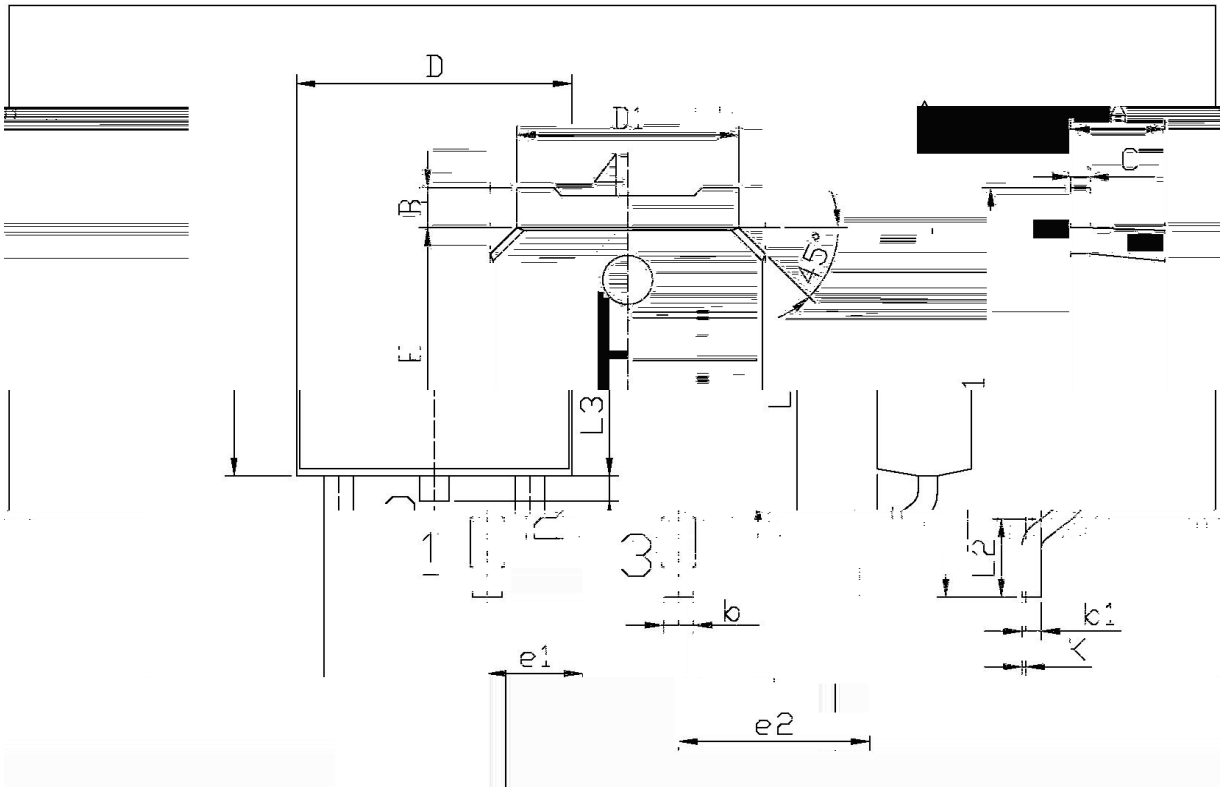
/ Electrical Characteristic Curve



/ Electrical Characteristic Curve



/ Package Dimensions

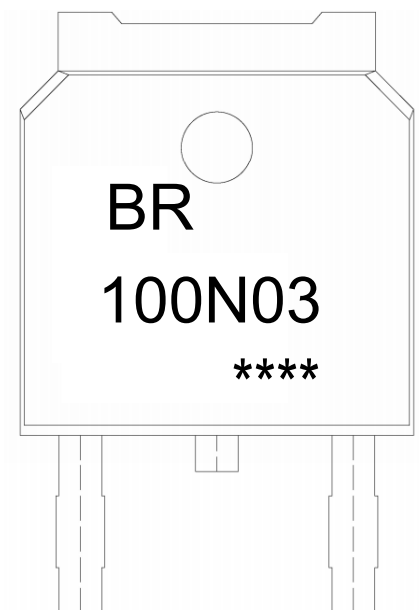


单位: mm

| Symbol | Dimension In Millimeters | | | Dimension In Millimeters | | |
|--------|--------------------------|----------|--------|--------------------------|--------|----------|
| Symbol | Metric | Imperial | Metric | Symbol | Metric | Imperial |
| 2.40 | 2.40 | 0.094 | 6.25 | B | 0.95 | 0.037 |
| 1.25 | e1 | 2.24 | 2.34 | | | |
| 0.45 | 0.45 | 0.018 | e2 | 7.75 | 0.305 | 0.012 |
| 0.45 | 0.55 | 0.022 | 9.85 | 10.35 | 0.409 | 0.016 |
| 1.70 | 2.00 | 0.079 | | 0.45 | 0.55 | 0.022 |
| 6.75 | L3 | 0.60 | 0.90 | D | 6.45 | 0.254 |
| E | 9.50 | 0.374 | 10.00 | D' | 7.10 | 0.279 |

T0-252

/ Marking Instructions



BR

100N03

Note:

BR: Company Code

100N03: Product Type.

****: Lot No. Code, code change with Lot No.



() / Temperature Profile for IR Reflow Soldering(Pb-Free)

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- 1. Preheating: 150~180°C, Time:60~90sec.
- 2. Peak Temperature: 245±5°C, Duration:5±0.5sec.
- 3. Cooling Speed: 2~10°C/sec.

/ Resistance to Soldering Heat Test Conditions

260±5°C 10±1 sec. Temp. Time:10±1 sec

/ Packaging SPEC.

/ BULK

| Package Type 封装形式 | Units 包装数量 | | | | | Dimension 包装尺寸 (unit: mm ³) | |
|----------------------|------------------|-----------------------|------------------------|------------------------------|------------------------|---|-------------|
| | Units/Bag 只/袋 | Bags/Inner Box 袋/盒 | Units/Inner Box 只/盒 | Inner Boxes/Outer Box 盒/箱 | Units/Outer Box 只/箱 | Inner Box 盒 | Outer Box 箱 |
| TO-252 | 2,500 | 2 | 5,000 | 6 | 30,000 | 360×360×50 | 380×335×366 |

/ TUBE

| Package Type 封装形式 | Units 包装数量 | | | | | Dimension 包装尺寸 (unit: mm ³) | |
|----------------------|--------------------|-------------------------|------------------------|------------------------------|------------------------|---|-------------|
| | Units/Tube 只/套管 | Tubes/Inner Box 套管/盒 | Units/Inner Box 只/盒 | Inner Boxes/Outer Box 盒/箱 | Units/Outer Box 只/箱 | Inner Box 盒 | Outer Box 箱 |
| TO-251/252 | 75 | 48 | 3,600 | 5 | 18,000 | 520×360×50 | 540×335×366 |